

## PACKAGING INFORMATION

| Orderable Device | Status | Package Type | •       | Pins | •    | Eco Plan     | Lead finish/  | MSL Peak Temp       | Op Temp (°C) | Device Marking | Samples |
|------------------|--------|--------------|---------|------|------|--------------|---------------|---------------------|--------------|----------------|---------|
|                  | (1)    |              | Drawing |      | Qty  | (2)          | Ball material | (3)                 |              | (4/5)          |         |
|                  |        |              |         |      |      |              | (6)           |                     |              |                |         |
| SN74CBT3251D     | NRND   | SOIC         | D       | 16   | 40   | RoHS & Green | NIPDAU        | Level-1-260C-UNLIM  | -40 to 85    | CBT3251        |         |
| SN74CBT3251DBQR  | NRND   | SSOP         | DBQ     | 16   | 2500 | RoHS & Green | NIPDAU        | Level-2-260C-1 YEAR | -40 to 85    | CU251          |         |
| SN74CBT3251DBR   | NRND   | SSOP         | DB      | 16   | 2000 | RoHS & Green | NIPDAU        | Level-1-260C-UNLIM  | -40 to 85    | CU251          |         |
| SN74CBT3251DR    | ACTIVE | SOIC         | D       | 16   | 2500 | RoHS & Green | NIPDAU        | Level-1-260C-UNLIM  | -40 to 85    | CBT3251        | Samples |
| SN74CBT3251PW    | NRND   | TSSOP        | PW      | 16   | 90   | RoHS & Green | NIPDAU        | Level-1-260C-UNLIM  | -40 to 85    | CU251          |         |
| SN74CBT3251PWR   | ACTIVE | TSSOP        | PW      | 16   | 2000 | RoHS & Green | NIPDAU        | Level-1-260C-UNLIM  | -40 to 85    | CU251          | Samples |
| SN74CBT3251RGYR  | ACTIVE | VQFN         | RGY     | 16   | 3000 | RoHS & Green | NIPDAU        | Level-2-260C-1 YEAR | -40 to 85    | CU251          | Samples |

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW**: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.



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## PACKAGE OPTION ADDENDUM

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